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FQA8N90C-F109

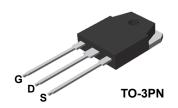
N-Channel QFET $^{\circledR}$ MOSFET 900 V, 8 A, 1.9 Ω

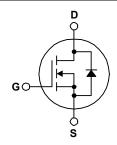
Features

- 8 A, 900 V, $R_{DS(on)}$ = 1.9 Ω (Max.) @ V_{GS} = 10 V, I_D = 4 V
- Low Gate Charge (Typ. 35 nC)
- Low Crss (Typ. 12 pF)
- 100% Avalanche Tested
- · RoHS Compliant

Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQA8N90C-F109	Unit
V _{DSS}	Drain-Source Voltage		900	V
I _D	Drain Current - Continuous (T _C = 25°C)		8.0	Α
	- Continuous (T _C = 100°C)		5.1	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	32	Α
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	850	mJ
I _{AR}	Avalanche Current (N		8.0	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)		24	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.0	V/ns
P _D	Power Dissipation (T _C = 25°C)		240	W
	- Derate above 25°C		1.92	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FQA8N90C-F109	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.52	°C/W
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.24	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQA8N90C-F109	FQA8N90C	TO-3PN	Tube	N/A	N/A	30 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_{D} = 250 μ A	900			V
$\Delta BV_{DSS}/$ ΔT_{J}	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		0.95		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 900 V, V _{GS} = 0 V			10	μА
		V _{DS} = 720 V, T _C = 125°C			100	μА
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V	-		100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Charac	teristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 4.0 A		1.6	1.9	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 4.0 A	1	5.5		S
Dynamic C	haracteristics					
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		1600	2080	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		130	170	pF
C _{rss}	Reverse Transfer Capacitance	-	-	12	15	pF
Switching (Characteristics					
t _{d(on)}	Turn-On Delay Time	V _{DD} = 450 V, I _D = 11.0A,		40	90	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$	-	110	230	ns
t _{d(off)}	Turn-Off Delay Time			70	150	ns
t _f	Turn-Off Fall Time	(Note 4)		70	150	ns
Qg	Total Gate Charge	V _{DS} = 720 V, I _D = 11.0A,		35	45	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V	-	10		nC
Q _{gd}	Gate-Drain Charge	(Note 4)	-	14		nC
Drain-Sour	ce Diode Characteristics and Maximum Ratings					
I _S	Maximum Continuous Drain-Source Diode Forward Current				8.0	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				32.0	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 8.0 A			1.4	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = 8.0 \text{ A},$		530		ns
Q _{rr}	Reverse Recovery Charge	$dI_F / dt = 100 A/\mu s$		5.8		μС

^{1.} Repetitive rating: pulse-width limited by maximum junction temperature.

^{2.} L = 25 mH, I_{AS} = 8 A, V_{DD} = 50 V, R_{G} = 25 Ω , starting T_{J} = 25°C.

 $^{3.\}text{I}_{SD} \leq 8 \text{ A, di/dt} \leq 200 \text{ A/}\mu\text{s, V}_{DD} \leq \text{BV}_{DSS}\text{, starting T}_J = 25^{\circ}\text{C}.$

^{4.} Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

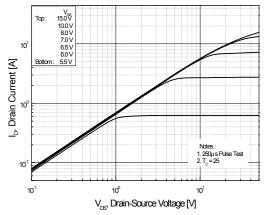


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

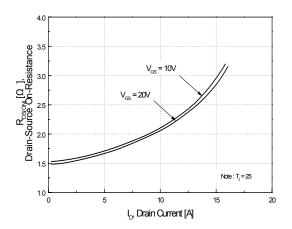


Figure 5. Capacitance Characteristics

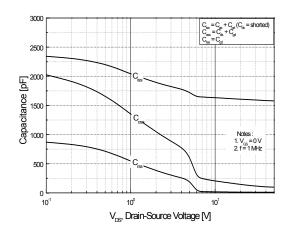


Figure 2. Transfer Characteristics

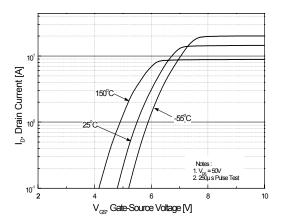


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperatue

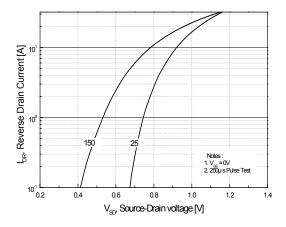
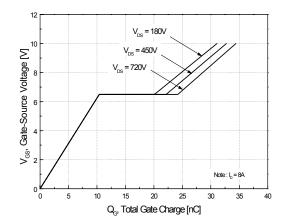


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

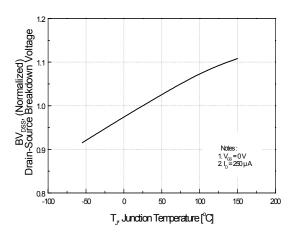


Figure 9. Maximum Safe Operating Area

Figure 8. On-Resistance Variation vs. Temperature

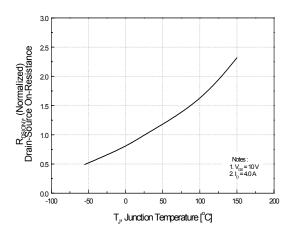


Figure 10. Maximum Drain Current vs. Case Temperature

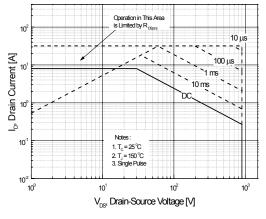
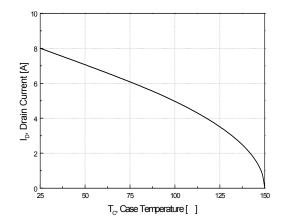
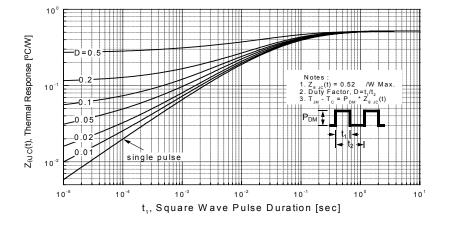


Figure 11. Transient Thermal Response Curve





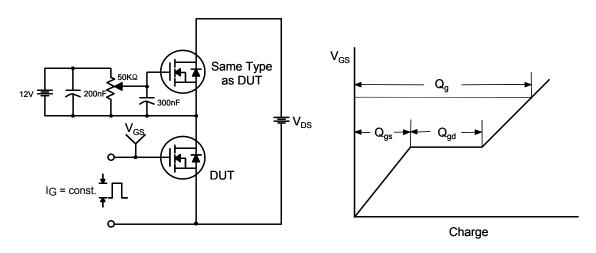


Figure 12. Gate Charge Test Circuit & Waveform

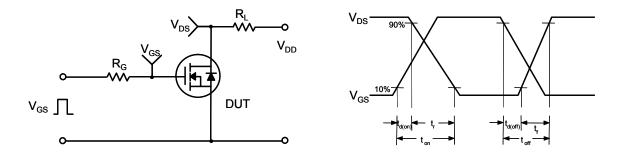


Figure 13. Resistive Switching Test Circuit & Waveforms

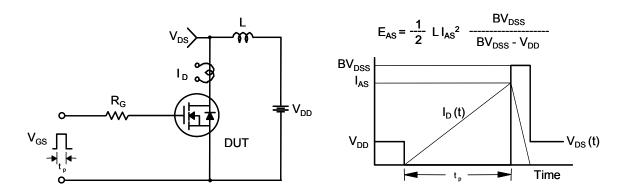
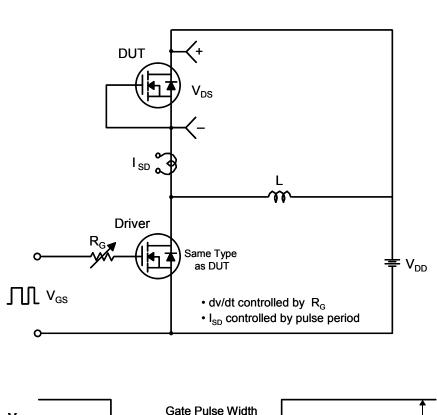


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



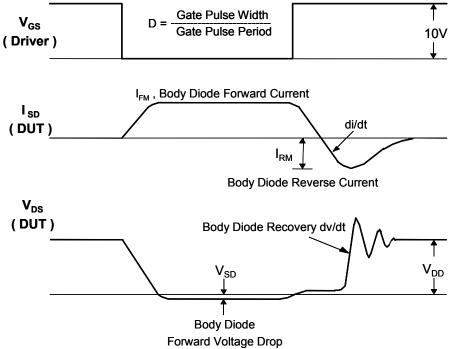


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

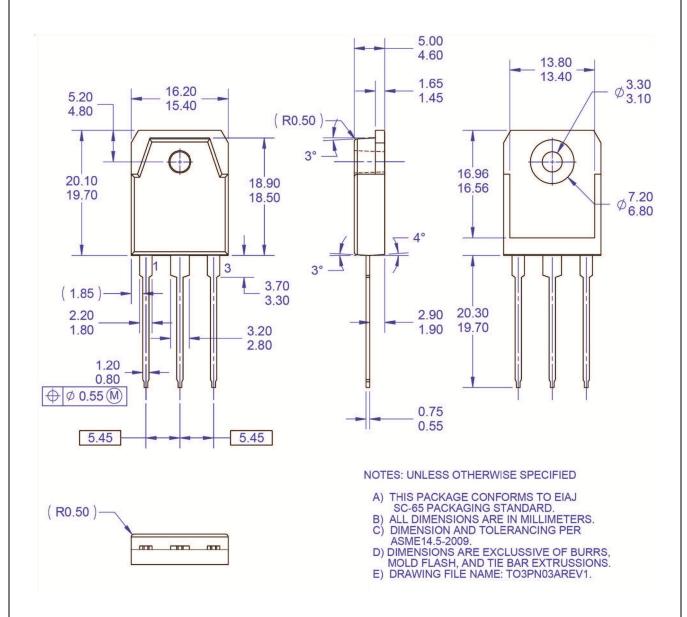


Figure 16. TO3PN, 3-Lead, Plastic, EIAJ SC-65

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